

## Description

### JMT N-channel Enhancement Mode Power MOSFET

#### Features

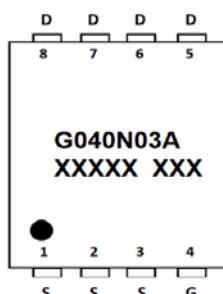
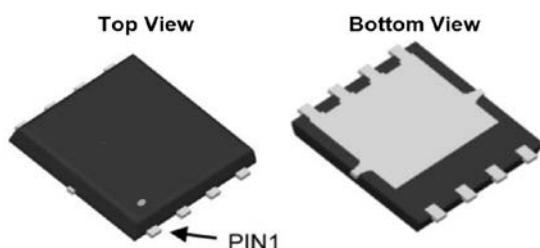
- 30V, 80A  
 $R_{DS(ON)} < 3.4\text{m}\Omega$  @  $V_{GS} = 10\text{V}$   
 $R_{DS(ON)} < 5.6\text{m}\Omega$  @  $V_{GS} = 4.5\text{V}$
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free

#### Applications

- Load Switch
- PWM Application
- Power Management

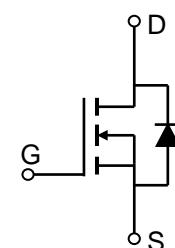


100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



PDFN5x6-8L

Marking and Pin Assignment



Schematic Diagram

#### Package Marking and Ordering Information

| Device Marking | Device      | Outline | Package    | Reel Size | Reel(pcs) | Per Carton (pcs) |
|----------------|-------------|---------|------------|-----------|-----------|------------------|
| G040N03A       | JMTG040N03A | TAPING  | PDFN5x6-8L | 13"       | 5000      | 50000            |

#### Absolute Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

| Symbol          | Parameter  |                           | Value      | Units                     |
|-----------------|--|---------------------------|------------|---------------------------|
| $V_{DS}$        | Drain-to-Source Voltage                                |                           | 30         | V                         |
| $V_{GS}$        | Gate-to-Source Voltage                                 |                           | $\pm 20$   | V                         |
| $I_D$           | Continuous Drain Current                               | $T_C = 25^\circ\text{C}$  | 80         | A                         |
|                 |  | $T_C = 100^\circ\text{C}$ | 51         |                           |
| $I_{DM}$        | Pulsed Drain Current <sup>(1)</sup>                    |                           | 320        | A                         |
| $E_{AS}$        | Single Pulsed Avalanche Energy <sup>(2)</sup>          |                           | 156        | mJ                        |
| $P_D$           | Power Dissipation                                      | $T_C = 25^\circ\text{C}$  | 25         | W                         |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient <sup>(3)</sup> |                           | 34         | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case                   |                           | 5.1        |                           |
| $T_J, T_{STG}$  | Junction & Storage Temperature Range                   |                           | -55 to 150 | $^\circ\text{C}$          |

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

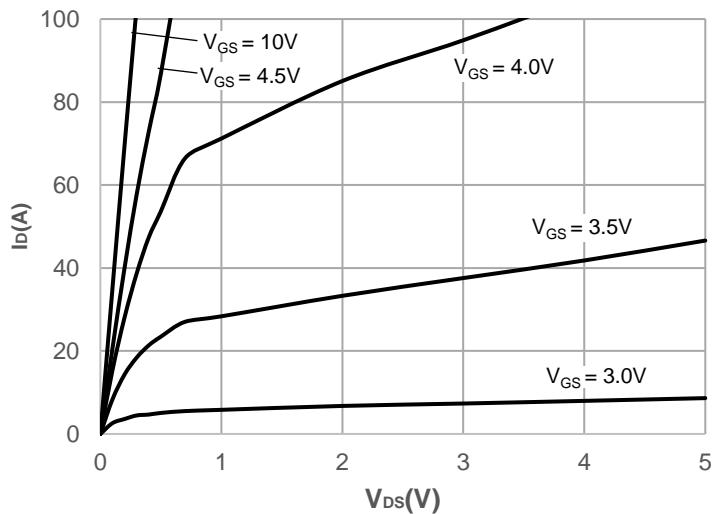
| Symbol  | Parameter  | Conditions   | Min. | Typ. | Max.      | Unit             |
|---|--|--|------|------|-----------|------------------|
| <b>Off Characteristics</b>                                |  |  |      |      |           |                  |
| $V_{(\text{BR})\text{DSS}}$                               | Drain-Source Breakdown Voltage                           | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$   | 30   | -    | -         | V                |
| $I_{\text{DSS}}$  | Zero Gate Voltage Drain Current                          | $V_{DS} = 30\text{V}, V_{GS} = 0\text{V}$  | -    | -    | 1.0       | $\mu\text{A}$    |
| $I_{\text{GSS}}$  | Gate-Body Leakage Current                                | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$  | -    | -    | $\pm 100$ | nA               |
| <b>On Characteristics</b>                                 |  |  |      |      |           |                  |
| $V_{GS(\text{th})}$                                       | Gate Threshold Voltage                                   | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$  | 1.3  | 1.9  | 2.5       | V                |
| $R_{\text{DS(ON)}}$                                       | Static Drain-Source ON-Resistance <sup>(4)</sup>         | $V_{GS} = 10\text{V}, I_D = 30\text{A}$  | -    | 2.6  | 3.4       | $\text{m}\Omega$ |
|   |  | $V_{GS} = 4.5\text{V}, I_D = 20\text{A}$   | -    | 4.3  | 5.6       | $\text{m}\Omega$ |
| <b>Dynamic Characteristics</b>                            |  |  |      |      |           |                  |
| $C_{\text{iss}}$  | Input Capacitance  | $V_{GS} = 0\text{V}, V_{DS} = 15\text{V}, f = 1\text{MHz}$                                 | -    | 3089 | -         | pF               |
| $C_{\text{oss}}$  | Output Capacitance                                       |  | -    | 372  | -         | pF               |
| $C_{\text{rss}}$  | Reverse Transfer Capacitance                             |  | -    | 302  | -         | pF               |
| $Q_g$   | Total Gate Charge  | $V_{GS} = 0 \text{ to } 10\text{V}$<br>$V_{DS} = 15\text{V}, I_D = 30\text{A}$             | -    | 58   | -         | nC               |
| $Q_{\text{gs}}$   | Gate Source Charge                                       |  | -    | 12   | -         | nC               |
| $Q_{\text{gd}}$   | Gate Drain("Miller") Charge                              |  | -    | 13   | -         | nC               |
| <b>Switching Characteristics</b>                          |  |  |      |      |           |                  |
| $t_{d(\text{on})}$  | Turn-On Delay Time                                       | $V_{GS} = 10\text{V}, V_{DD} = 15\text{V}$<br>$I_D = 30\text{A}, R_{\text{GEN}} = 3\Omega$ | -    | 11   | -         | ns               |
| $t_r$   | Turn-On Rise Time  |  | -    | 29   | -         | ns               |
| $t_{d(\text{off})}$                                       | Turn-Off Delay Time                                      |  | -    | 47   | -         | ns               |
| $t_f$   | Turn-Off Fall Time                                       |  | -    | 18   | -         | ns               |
| <b>Drain-Source Diode Characteristics and Max Ratings</b> |  |  |      |      |           |                  |
| $I_S$   | Maximum Continuous Drain to Source Diode Forward Current | -  | -    | 80   | -         | A                |
| $I_{\text{SM}}$   | Maximum Pulsed Drain to Source Diode Forward Current     | -  | -    | 320  | -         | A                |
| $V_{SD}$  | Drain to Source Diode Forward Voltage                    | $V_{GS} = 0\text{V}, I_S = 30\text{A}$   | -    | -    | 1.2       | V                |
| $\text{trr}$  | Body Diode Reverse Recovery Time                         | $I_F = 30\text{A}, dI/dt = 100\text{A/us}$   | -    | 16   | -         | ns               |
| $Q_{\text{rr}}$   | Body Diode Reverse Recovery Charge                       |  | -    | 7    | -         | nC               |

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

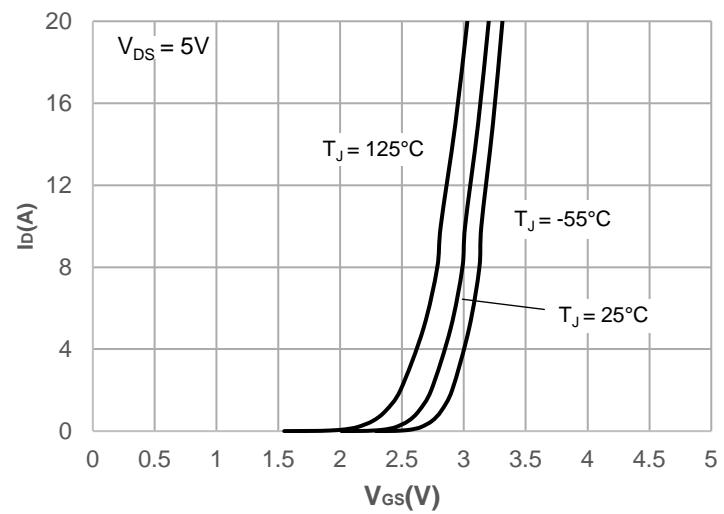
2. E<sub>AS</sub> condition: Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 15\text{V}$ ,  $V_G = 10\text{V}$ ,  $R_G = 25\text{ohm}$ ,  $L = 0.5\text{mH}$ ,  $I_{AS} = 25\text{A}$ 3.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB4. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

## Typical Performance Characteristics

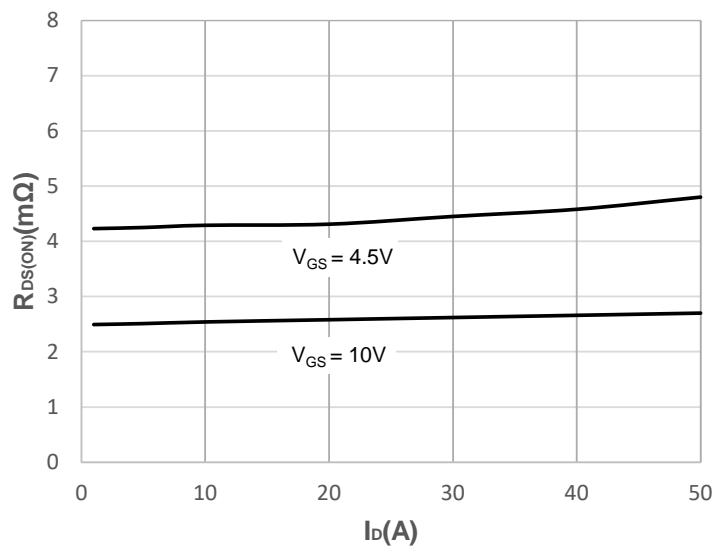
**Figure 1: Output Characteristics**



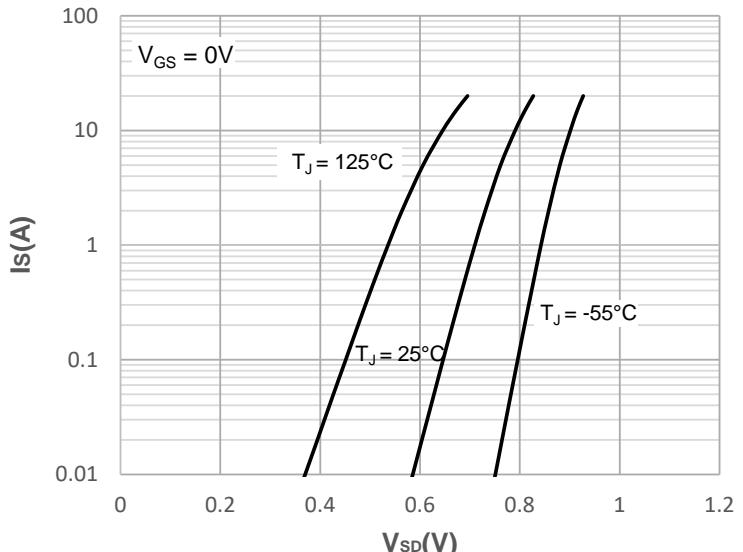
**Figure 2: Typical Transfer Characteristics**



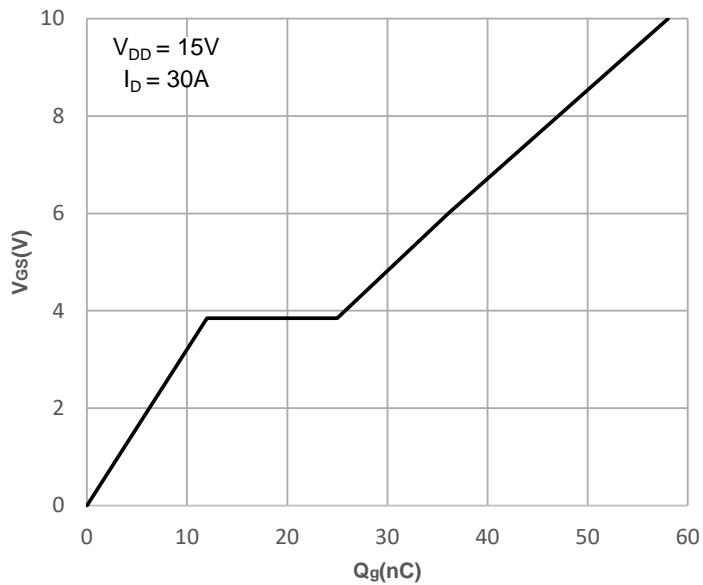
**Figure 3: On-resistance vs. Drain Current**



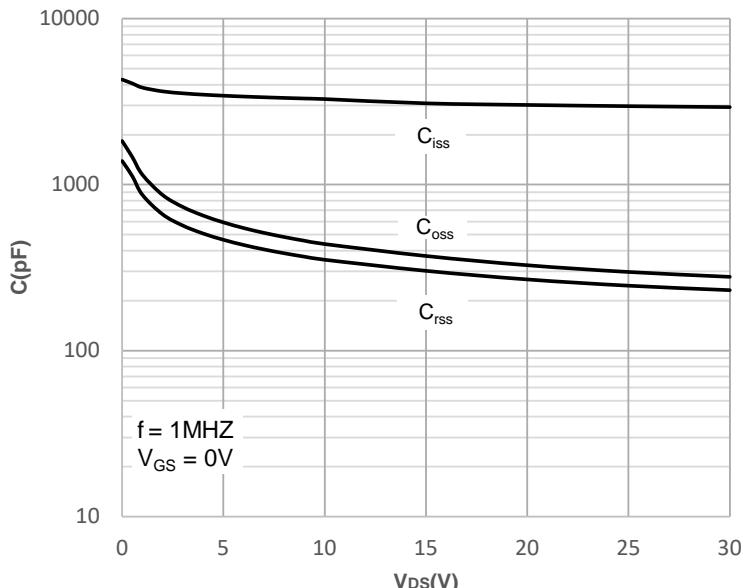
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**

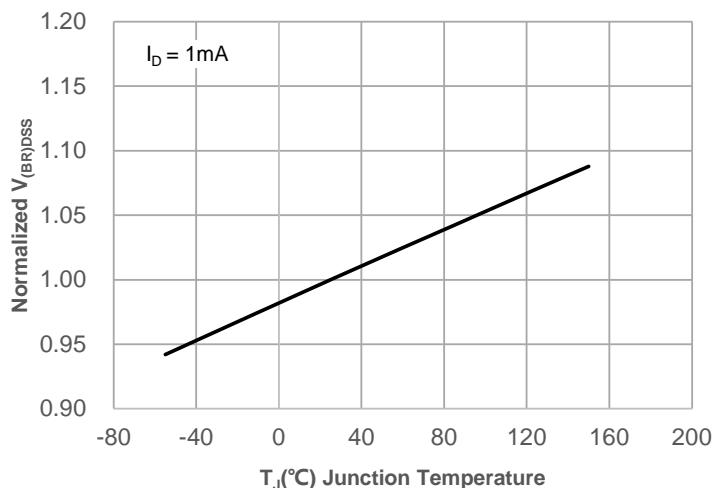


**Figure 6: Capacitance Characteristics**

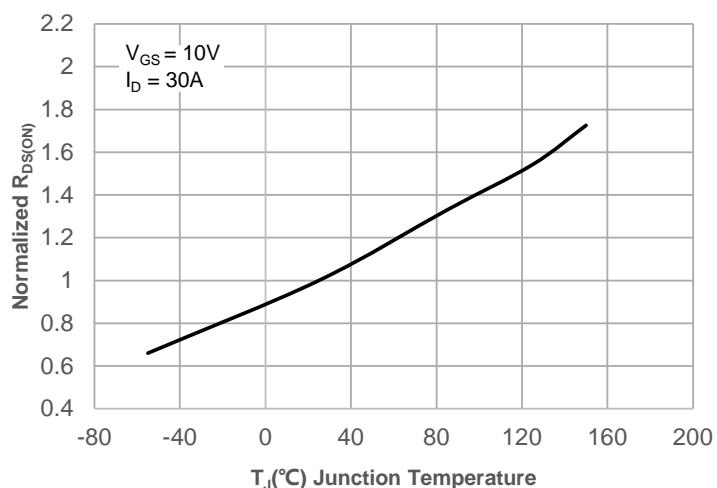


## Typical Performance Characteristics

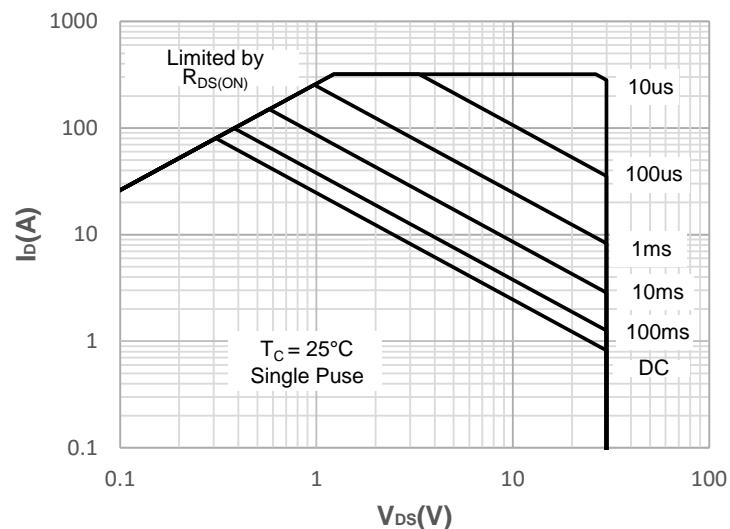
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



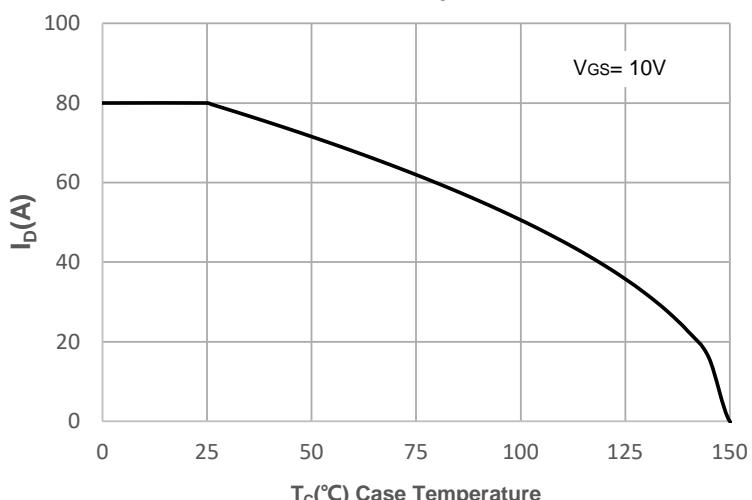
**Figure 8: Normalized on Resistance vs. Junction Temperature**



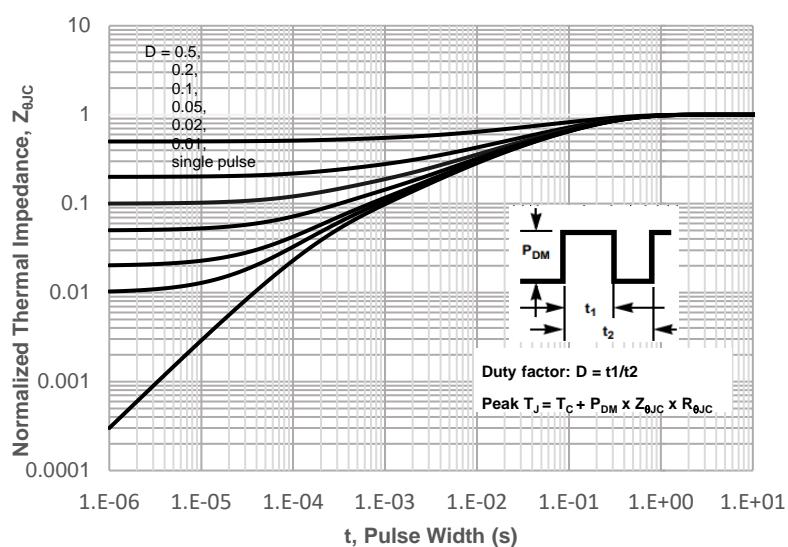
**Figure 9: Maximum Safe Operating Area**



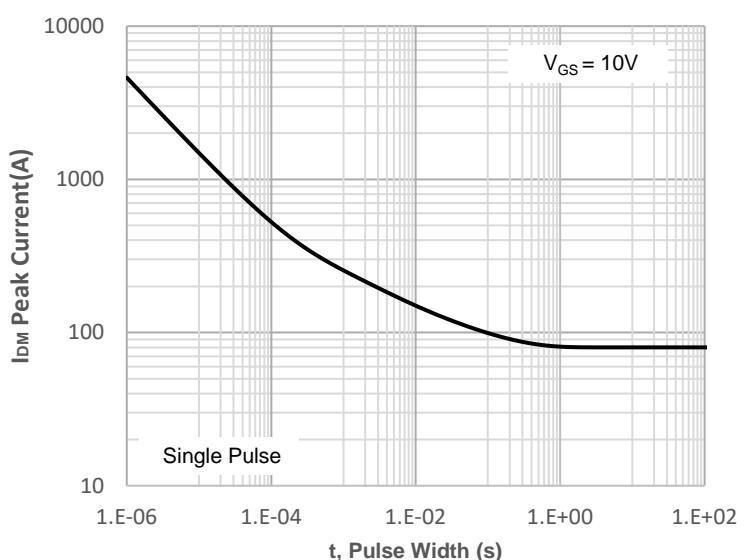
**Figure 10: Maximum Continuous Drain Current vs. Case Temperature**



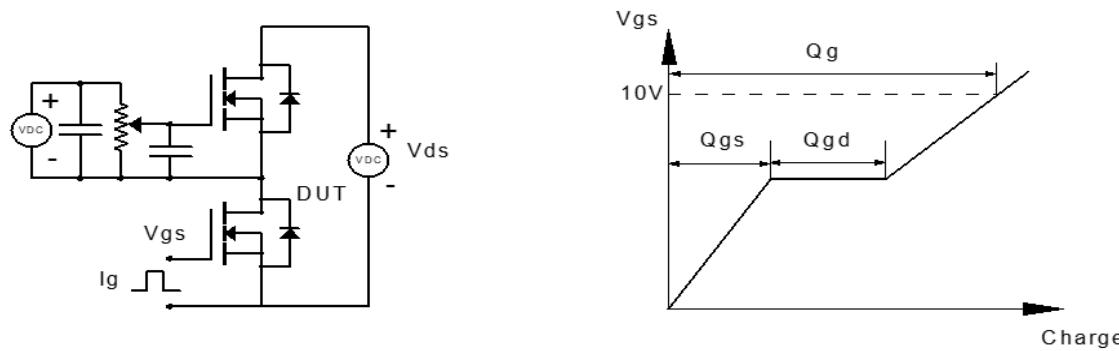
**Figure 11: Normalized Maximum Transient Thermal Impedance**



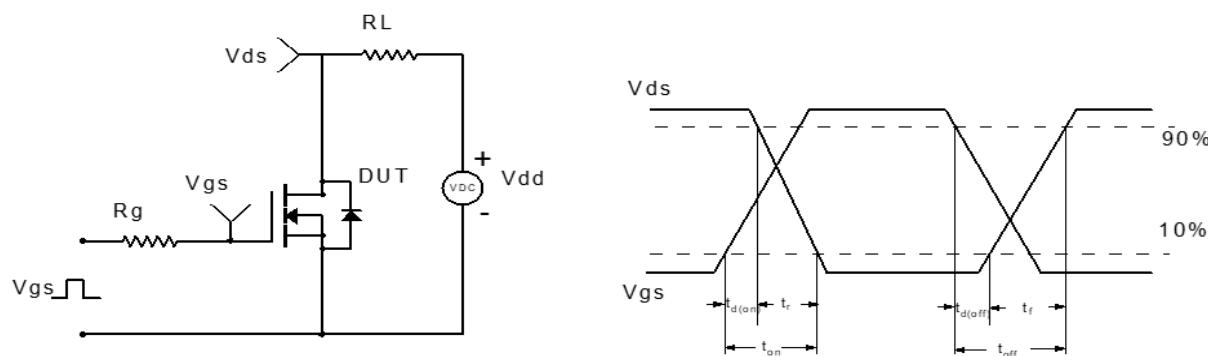
**Figure 12: Peak Current Capacity**



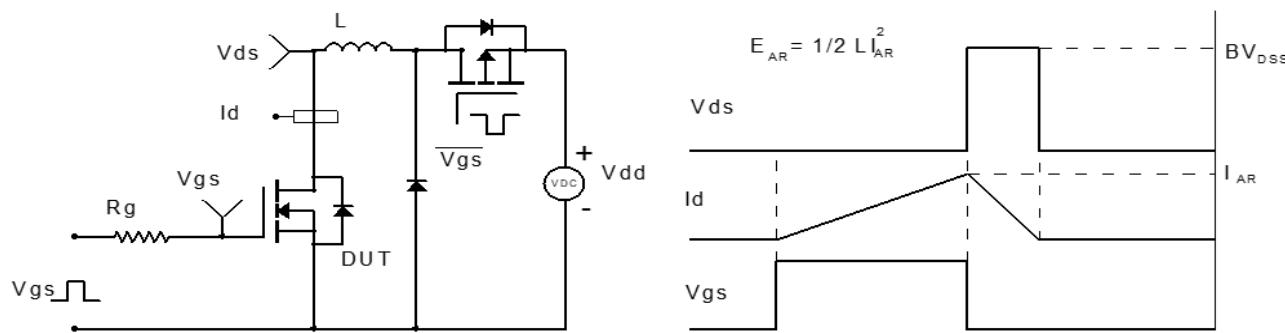
## Test Circuit



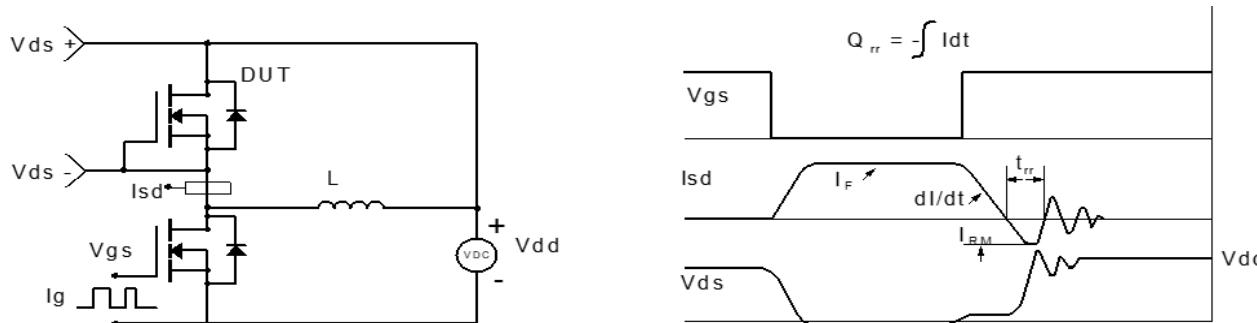
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

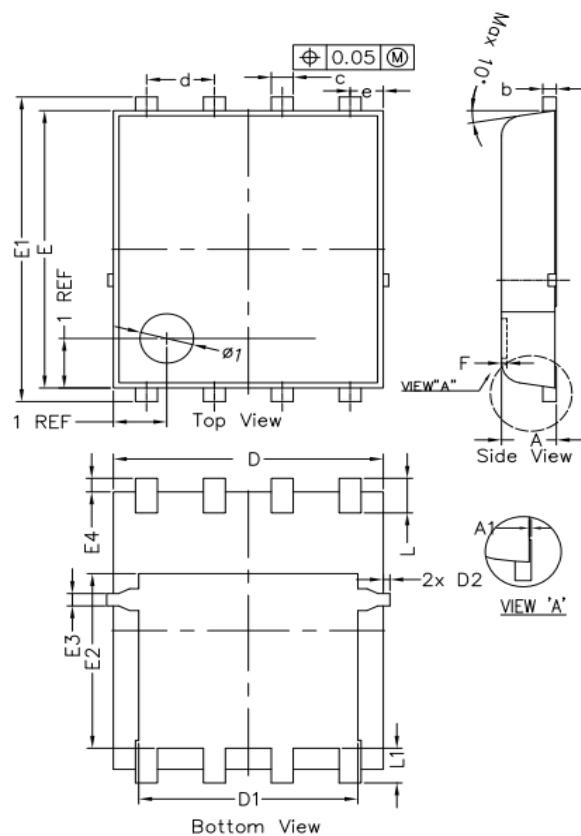


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(PDFN5x6-8L)



| SYMBOLS | DIMENSION IN MM |       |       | DIMENSION IN INCHES |       |       |
|---------|-----------------|-------|-------|---------------------|-------|-------|
|         | MIN             | NOM   | MAX   | MIN                 | NOM   | MAX   |
| * A     | 0.900           | 1.000 | 1.100 | 0.035               | 0.039 | 0.043 |
| A1      | 0.000           | ---   | 0.050 | 0.000               | ----  | 0.002 |
| b       | 0.246           | 0.254 | 0.312 | 0.010               | 0.010 | 0.012 |
| * c     | 0.310           | 0.410 | 0.510 | 0.012               | 0.016 | 0.020 |
| d       | 1.27 BSC        |       |       | 0.050 BSC           |       |       |
| * D     | 4.950           | 5.050 | 5.150 | 0.195               | 0.199 | 0.203 |
| D1      | 4.000           | 4.100 | 4.200 | 0.157               | 0.161 | 0.165 |
| * D2    | ---             | ---   | 0.125 | ---                 | ---   | 0.005 |
| e       | 0.62 BSC        |       |       | 0.024 BSC           |       |       |
| * E     | 5.500           | 5.600 | 5.700 | 0.217               | 0.220 | 0.224 |
| * E1    | 6.050           | 6.150 | 6.250 | 0.238               | 0.242 | 0.246 |
| E2      | 3.425           | 3.525 | 3.625 | 0.135               | 0.139 | 0.143 |
| E3      | 0.150           | 0.250 | 0.350 | 0.006               | 0.010 | 0.014 |
| * E4    | 0.175           | 0.275 | 0.375 | 0.007               | 0.011 | 0.015 |
| F       | -               | -     | 0.100 | -                   | -     | 0.004 |
| * L     | 0.500           | 0.600 | 0.700 | 0.02                | 0.02  | 0.03  |
| L1      | 0.600           | 0.700 | 0.800 | 0.02                | 0.03  | 0.03  |

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